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Results of SEL Testing Performed on Selected Components used in PCDF & MSL Equipments for ISS

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SUMMARY

A satellite with two large solar panel arrays is shown in space. The Earth is visible in the upper right corner, and the Moon is visible in the lower left corner. The background is a dark, star-filled space.

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SUMMARY

- 1 General Information**
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- 3 ISS-MSL Equipment**
- 4 Test Result Summary and Remarks**
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GENERAL INFORMATION

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GENERAL INFORMATION (1)

SCOPE:

- ❑ Single Event Latch-up (SEL) testing on selected components used in equipments and experiments for International Space Station (ISS)
- ❑ Minimum project SEL LET_{eff} threshold of 36 MeV cm²/mg
- ❑ Further major test goals
 - ⇒ Testing up to at least twice the SEL threshold requirement
 - ⇒ Where applicable other effects like SEB, SEGR should be detected and analysed
 - ⇒ Two components of each selected part type should be tested
 - ⇒ Application conditions or “worst case” bias should be applied
 - ⇒ Test candidate harmonizing between parts in various ISS equipments
- ❑ Irradiation test facility
 - ⇒ ESA Heavy Ion Test Facility (HIF) at UCL, Belgium

GENERAL INFORMATION (2)

ISS EQUIPMENT COMPRISED:

❑ PCDF:

- ⇒ EEE Parts Lists supplied by
 - Chevalier Photonics for components used in ISS/COF
 - Papst for components used in fans

❑ MSL:

- ⇒ EEE Parts Lists supplied by
 - Astrium Space Infrastructure Division for components used in CAM equipment of MSL

GENERAL INFORMATION (3)

WORK STRUCTURE:

- ❑ Phase 1 involved
 - ⇒ Review and analysis of EEE parts lists to identify all SEL sensitive parts
 - ⇒ Identification and selection of test candidates with subsequent approval of project and ESA
- ❑ Phase 2 involved
 - ⇒ Preparation and approval of Test Plan and test hardware development
- ❑ Phase 3 involved
 - ⇒ SEL testing using ESA HIF at UCL
- ❑ Phase 4 involved
 - ⇒ Summary of test results and reporting

ISS-PCDF EQUIPMENT

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ISS-PCDF EQUIPMENT (1)

ISS-PCDF COMPONENT PARTS SELECTION:

- ❑ Component Parts Lists
 - ⇒ 3 parts lists supplied from Chevalier Photonics
 - ⇒ 2 parts lists supplied from Papst

- ❑ Identified components types
 - ⇒ 30 component types identified as potentially sensitive to SEL
 - 9 component types had SEL LET_{eff} threshold data $>36 \text{ MeV cm}^2/\text{mg}$
 - 3 component types were later identified as not SEL sensitive
(based upon information and correspondence with manufacturer)
 - 18 component types finally selected for SEL testing

- ❑ PCDF Review Report, REP-002, Issue 1 of 17.11.2000

ISS-PCDF EQUIPMENT (2)

❑ ISS-PCDF SEL irradiated part types:

– JANTXV2N6782	N-Channel HEXFET	Intersil
– JANTXV2N6845	P-Channel HEXFET	International Rectifier
– SNJ55ALS194J	Line Driver	Texas Instruments
– SNJ55ALS195J	Line Receiver	Texas Instruments
– LT1086MH/883	Positive Voltage Regulator	Linear Technology
– AS5C4008F-25	512K x 8 SRAM	Austin Semiconductor
– AD822AR	FET Input Operational Amplifier	Analog Devices
– AD9816JS	12-bit Digital Signal Processor	Analog Devices
– M55310/28-B11A	20 MHz Oscillator	Corning Frequency Control, Inc.
– MIC4452BM	CMOS MOSFET Driver	Micrel Semiconductor
– 54ACTQ04LMQB	CMOS Hex Inverter	National Semiconductor
– 54FCT245T	8-bit Bus Transceiver	Integrated Device Technology
– JD54F38BCA	NAND Buffer Driver	National Semiconductor
– 54HCT04	Hex Inverter	Texas Instruments
– AD620SQ	Operational Amplifier	Analog Devices
– LM2991J-QML	Voltage Regulator	National Semiconductor
– DG406AK/883	16-ch. CMOS Analog Multiplexer	Siliconix
– LM117H/883	Voltage Regulator	National Semiconductor

ISS-MSL EQUIPMENT

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ISS-MSL EQUIPMENT (1)

ISS-MSL COMPONENT PARTS SELECTION:

- ❑ Component Parts Lists
 - ⇒ 15 parts lists supplied from Astrium Space Infrastructure Division
- ❑ Identified components types
 - ⇒ 89 component types identified as potentially sensitive to SEL
 - 9 component types had SEL LET_{eff} threshold data >36 MeV cm²/mg
 - 28 component types were assessed to have a possible SEL LET threshold < 36 MeV cm²/mg
 - 20 component types finally selected for SEL testing
- ❑ MSL Assessment Report, REP-001, Issue 1 of 06.07.2000

ISS-MSL EQUIPMENT (2)

❑ ISS-MSL SEL irradiated part types:

– SAB80C166M	16-bit CMOS Microcontroller	Infineon
– ST62C65CB6	8-bit CMOS Microcontroller	STM
– LMC6062/883	CMOS Operational Amplifier	National Semiconductor
– LMC662AIN	CMOS Operational Amplifier	National Semiconductor
– TLC272BCP	CMOS Operational Amplifier	Texas Instruments
– LT1298IN8	12-bit ADC	Linear Technology
– MAX538BEPA	12-bit DAC	Maxim
– FM93C56EN	2K CMOS EEPROM	Fairchild
– TL7705ACP	Bipolar Voltage Supervisor	Texas Instruments
– PIC16-F84-04I/P	8-bit CMOS Microcontroller	Microchip Technology
– MAX328CJE	8-ch. CMOS Analog Multiplexer	Maxim
– AD7228ACQ	8-bit BiCMOS DAC	Analog Devices
– AD7846AQ	16-bit BiCMOS DAC	Analog Devices
– 80C196KC-20	16-bit CMOS Microcontroller	Intel
– DS1225Y-200	64K CMOS SRAM	Dallas
– COM20020IP	8-bit CMOS LAN Controller	Standard Microsysteme
– PSD301-B-90JI	CMOS Programmable Peripheral	Wafer Scale Integration
– K6T1008C2E-DB70	1M CMOS SRAM	Samsung
– LMC6482AMJ/883	CMOS Operational Amplifier	National Semiconductor
– ICM7555MJA	CMOS Analog Timer	Maxim

TEST RESULT SUMMARY AND REMARKS

**Results of SEL Testing Performed on Selected Components
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TEST RESULT SUMMARY AND REMARKS (1)

ISS-PCDF TEST RESULT SUMMARY:

- ❑ 18 component types tested between an SEL LET_{eff} range of 5.85 and 73 MeV cm²/mg
- ❑ Test results
 - ⇒ 14 types had an SEL LET_{eff} threshold >73 MeV cm²/mg
 - ⇒ 1 type (LT1086) showed SEL at 34 MeV cm²/mg but not at 28.2 MeV cm²/mg
 - ⇒ 2 types (AD9816, LM117) showed SEL at 14.1 MeV cm²/mg but not at 9.1 MeV cm²/mg
 - ⇒ 1 type (LM2991) showed SEL at 5.85 MeV cm²/mg which was the lowest LET_{eff} used

TEST RESULT SUMMARY AND REMARKS (2)

ISS-MSL TEST RESULT SUMMARY:

- ❑ 20 component types tested between an SEL LET_{eff} range of 5.85 and 73 MeV cm^2/mg
- ❑ Test results
 - ⇒ 11 types had an SEL LET_{eff} threshold >73 MeV cm^2/mg
 - ⇒ 1 type (DS1225Y) showed SEL at 34 MeV cm^2/mg but not at 14.1 MeV cm^2/mg . Note: High supply current prevented reliable data
 - ⇒ 1 type (PSD301) showed SEL at 28.2 MeV cm^2/mg but not at 19.9 MeV cm^2/mg
 - ⇒ 1 type (80C196) showed SEL at 19.9 MeV cm^2/mg but not at 14.1 MeV cm^2/mg

TEST RESULT SUMMARY AND REMARKS (3)

❑ ISS-MSL Test results (cont.)

⇒ 5 types (SAB80C166, ST62C65, FM93C56, PIC16-F84, COM20020IP) showed SEL at 14.1 MeV cm²/mg but not at 9.1 MeV cm²/mg

⇒ 1 type (LTC1298) showed SEL at 9.1 MeV cm²/mg but not at 5.85 MeV cm²/mg

❑ At an LET_{eff} of 5.85 MeV cm²/mg no SEL was detected at any part type

TEST RESULT SUMMARY AND REMARKS (4)

TEST RESULT REMARKS:

- ❑ 38 component types, mostly of COTS quality, have been SEL tested
 - ⇒ 25 types passed project SEL requirements, i.e. LET_{eff} threshold of 36 MeV cm²/mg or greater
 - ⇒ 13 types **(34%)** failed the relatively low project SEL requirement
 - ⇒ 9 types showed very sensitive results, i.e. LET_{eff} threshold of 14.1 MeV cm²/mg or below
- ❑ Possible reasons for poor results
 - ⇒ Unknown technology, quality and performance for COTS
 - ⇒ Equipment manufacturers inexperience w.r.t. space radiation requirements
 - ⇒ Use of existing equipment designs not intended for space usage

TEST RESULT SUMMARY AND REMARKS (5)

TEST RESULT REMARKS (cont.):

- ❑ Possible consequences of poor results
 - ⇒ Component replacement
 - ⇒ Circuit / equipment redesign (latch-up protection, etc.)
 - ⇒ Significant project delays and cost increase
 - ⇒ Reduction of circuit / equipment performance

- ❑ Possible improvements
 - ⇒ Use of known radiation tolerant components
 - ⇒ Involvement of radiation expertise at an early project phase should be mandatory

TEST RESULT SUMMARY AND REMARKS (6)

REPORT REFERENCES:

☐ PCDF

- ⇒ Irradiation Test Report, ITR_926_01_1.pdf, Issue 1 of 19.07.2001
- ⇒ Irradiation Test Plan, ITP_01_01_1A.pdf, Issue 1A of 03.05.2001

☐ MSL

- ⇒ Irradiation Test Report, ITR_927_01_1.pdf, Issue 1 of 22.10.2001
- ⇒ Irradiation Test Plan, ITP_02_01_1A.pdf, Issue 1A of 07.09.2001

☐ All test reports are available at ESA-QCA

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